

## Low drop power Schottky rectifier

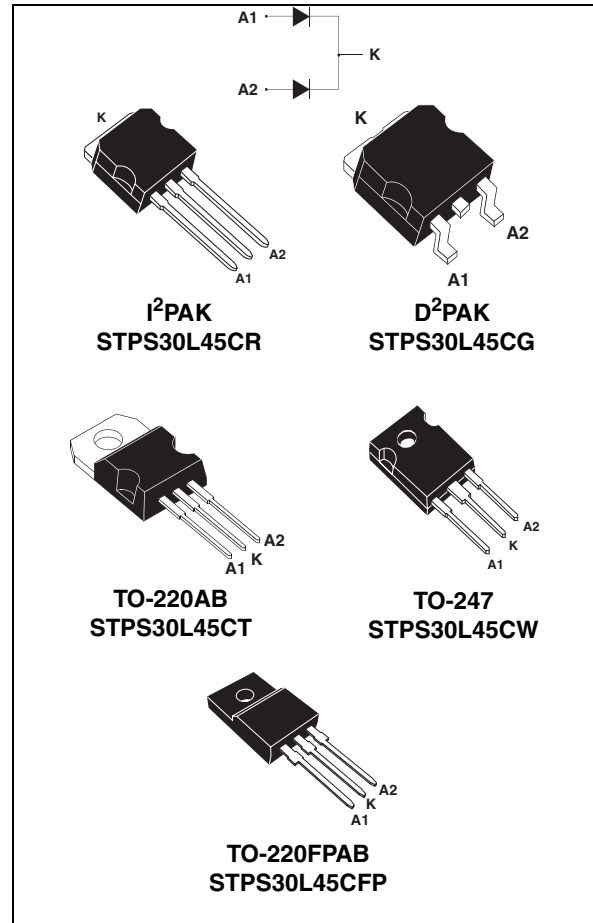
### Features

- low forward voltage drop meaning very small conduction losses
- low switching losses allowing high frequency operation
- low thermal resistance
- avalanche rated
- insulated package TO-220FPAB:
  - insulating voltage = 2000 V DC
  - capacitance = 45 pF
- avalanche capability specified

### Description

Dual center tap Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters.

Packaged in TO-247, TO-220AB, TO-220FPAB, D<sup>2</sup>PAK and I<sup>2</sup>PAK this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



**Table 1. Device summary**

|             |          |
|-------------|----------|
| $I_{F(AV)}$ | 2 x 15 A |
| $V_{RRM}$   | 45 V     |
| $T_j$ (max) | 150 °C   |
| $V_F$ (max) | 0.5 V    |

# 1 Characteristics

**Table 2. Absolute Ratings (limiting values, per diode)**

| Symbol       | Parameter                                             |                                                          |                                                      |                                                                | Value        | Unit               |
|--------------|-------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------|----------------------------------------------------------------|--------------|--------------------|
| $V_{RRM}$    | Repetitive peak reverse voltage                       |                                                          |                                                      |                                                                | 45           | V                  |
| $I_{F(RMS)}$ | Forward rms current                                   |                                                          |                                                      |                                                                | 30           | A                  |
| $I_{F(AV)}$  | Average forward current                               | TO-220FPAB                                               | $T_c = 110\text{ }^{\circ}\text{C}$ , $\delta = 0.5$ | Per diode                                                      | 15           | A                  |
|              |                                                       | TO-220AB, TO-247, I <sup>2</sup> PAK, D <sup>2</sup> PAK | $T_c = 135\text{ }^{\circ}\text{C}$ , $\delta = 0.5$ | Per device                                                     | 30           |                    |
| $I_{FSM}$    | Surge non repetitive forward current                  |                                                          |                                                      | $t_p = 10\text{ ms Sinusoidal}$                                | 220          | A                  |
| $I_{RRM}$    | Repetitive peak reverse current                       |                                                          |                                                      | $t_p = 2\text{ }\mu\text{s square F} = 1\text{ kHz}$           | 1            | A                  |
| $I_{RSM}$    | Non repetitive peak reverse current                   |                                                          |                                                      | $t_p = 100\text{ }\mu\text{s square}$                          | 3            | A                  |
| $P_{ARM}$    | Repetitive peak avalanche power                       |                                                          |                                                      | $t_p = 1\text{ }\mu\text{s } T_j = 25\text{ }^{\circ}\text{C}$ | 6000         | W                  |
| $T_{stg}$    | Storage temperature range                             |                                                          |                                                      |                                                                | -65 to + 150 | $^{\circ}\text{C}$ |
| $T_j$        | Maximum operating junction temperature <sup>(1)</sup> |                                                          |                                                      |                                                                | 150          | $^{\circ}\text{C}$ |
| $dV/dt$      | Critical rate of rise of reverse voltage              |                                                          |                                                      |                                                                | 10000        | V/ $\mu\text{s}$   |

1.  $\frac{dP_{Tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal resistances**

| Symbol        | Parameter        |                                                          |           | Value | Unit                 |
|---------------|------------------|----------------------------------------------------------|-----------|-------|----------------------|
| $R_{th(j-c)}$ | Junction to case | TO-220FPAB                                               | Per diode | 4     | $^{\circ}\text{C/W}$ |
|               |                  |                                                          | Total     | 3.2   |                      |
|               |                  | TO-220AB, TO-247, I <sup>2</sup> PAK, D <sup>2</sup> PAK | Per diode | 1.60  |                      |
|               |                  |                                                          | Total     | 0.85  |                      |
| $R_{th(c)}$   | Coupling         | TO-220FPAB                                               |           | 2.5   | $^{\circ}\text{C/W}$ |
|               |                  | TO-220AB, TO-247, I <sup>2</sup> PAK, D <sup>2</sup> PAK |           | 0.10  |                      |

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode 1}) = P(\text{diode1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$$

Table 4. Static electrical characteristics (per diode)

| Symbol      | Parameter               | Test Conditions                     |                     | Min. | Typ. | Max. | Unit |
|-------------|-------------------------|-------------------------------------|---------------------|------|------|------|------|
| $I_R^{(1)}$ | Reverse leakage current | $T_J = 25\text{ }^{\circ}\text{C}$  | $V_R = V_{RRM}$     |      |      | 0.4  | mA   |
|             |                         | $T_J = 125\text{ }^{\circ}\text{C}$ |                     |      | 100  | 200  | mA   |
| $V_F^{(1)}$ | Forward voltage drop    | $T_J = 25\text{ }^{\circ}\text{C}$  | $I_F = 15\text{ A}$ |      |      | 0.55 | V    |
|             |                         | $T_J = 125\text{ }^{\circ}\text{C}$ | $I_F = 15\text{ A}$ |      | 0.42 | 0.50 |      |
|             |                         | $T_J = 25\text{ }^{\circ}\text{C}$  | $I_F = 30\text{ A}$ |      |      | 0.74 |      |
|             |                         | $T_J = 125\text{ }^{\circ}\text{C}$ | $I_F = 30\text{ A}$ |      | 0.59 | 0.67 |      |

1. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

To evaluate the conduction losses use the following equation:  $P = 0.330 \times I_{F(AV)} + 0.011 I_F^2_{(RMS)}$

Figure 1. Average forward power dissipation versus average forward current (per diode)

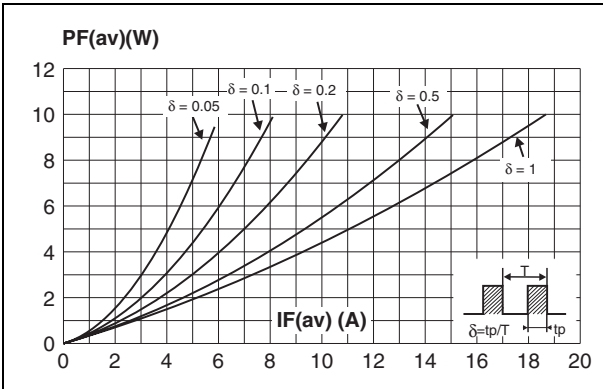


Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ , per diode)

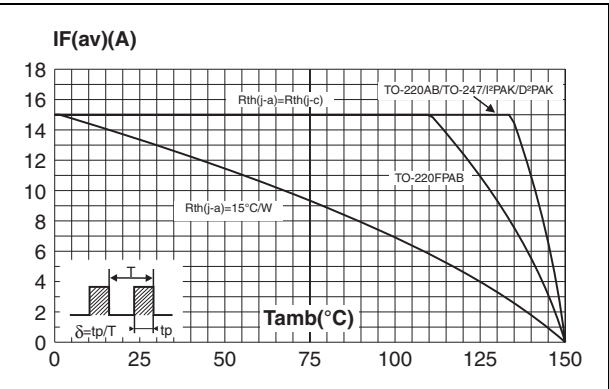


Figure 3. Normalized avalanche power derating versus pulse duration

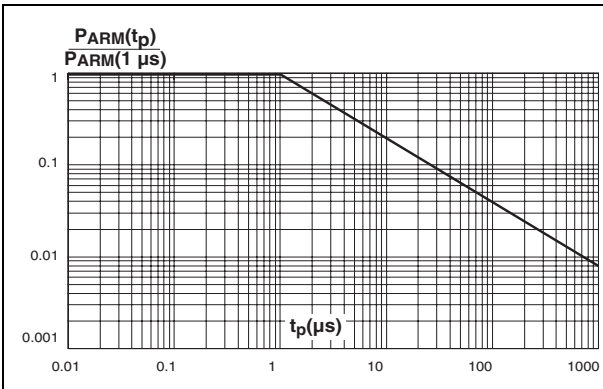
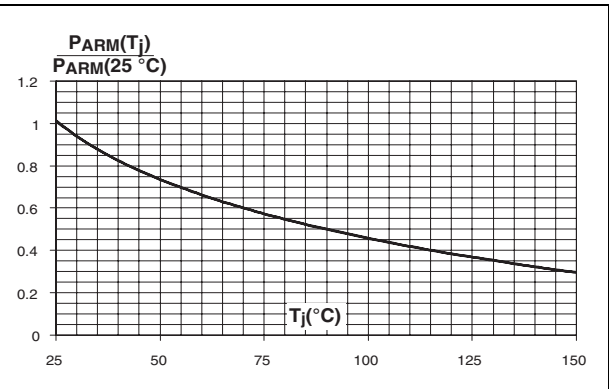
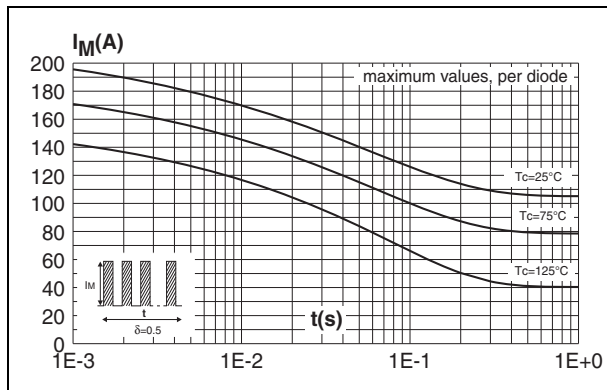


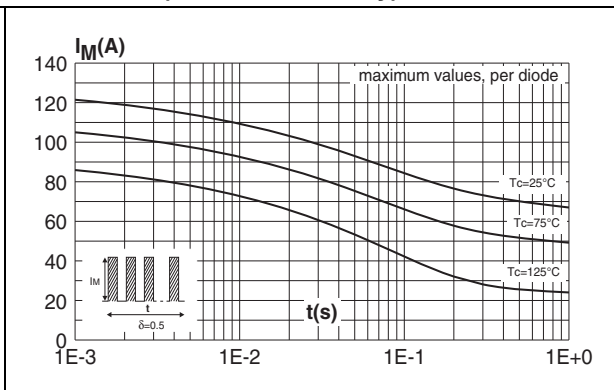
Figure 4. Normalized avalanche power derating versus junction temperature



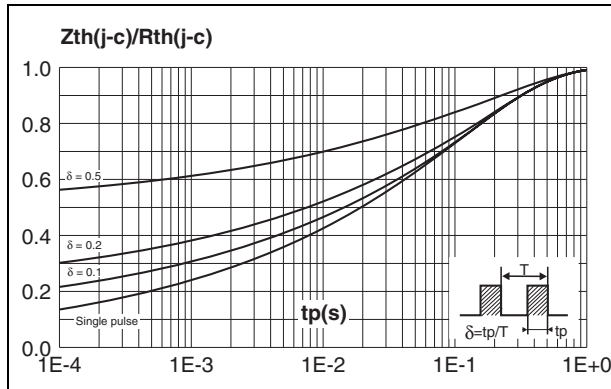
**Figure 5. Non repetitive surge peak forward current versus overload duration**



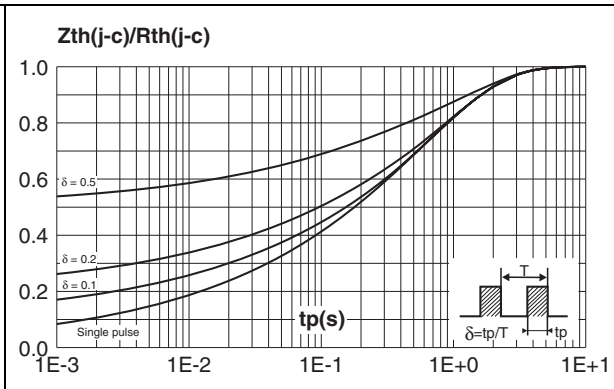
**Figure 6. Non repetitive surge peak forward current versus overload duration (TO-220FPAB only)**



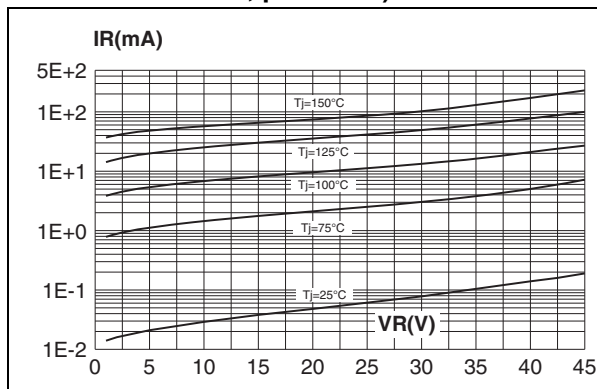
**Figure 7. Relative variation of thermal impedance junction to case versus pulse duration**



**Figure 8. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAB)**



**Figure 9. Reverse leakage current versus reverse voltage applied (typical values, per diode)**



**Figure 10. Junction capacitance versus reverse voltage applied (typical values, per diode)**

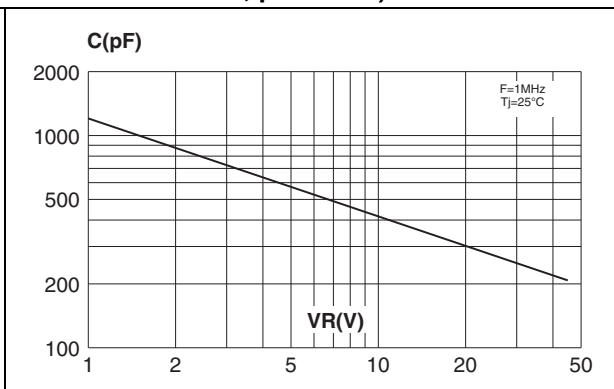


Figure 11. Forward voltage drop versus forward current (maximum values, per diode)

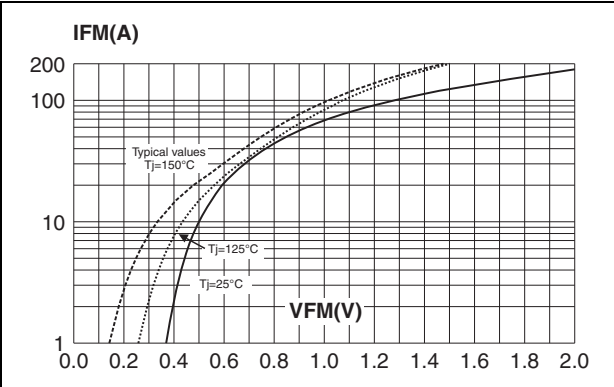
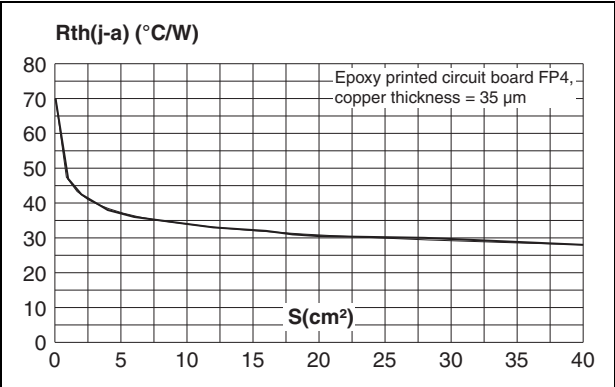


Figure 12. Thermal resistance junction to ambient versus copper surface under tab for D<sup>2</sup>PAK



## 2 Package Information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque (TO-220AB, TO-220FPAB): 0.4 to 0.6 N·m

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**Table 5. TO-220AB package dimensions**

| Ref  | Dimensions  |       |            |       |
|------|-------------|-------|------------|-------|
|      | Millimeters |       | Inches     |       |
|      | Min.        | Max.  | Min.       | Max.  |
| A    | 4.40        | 4.60  | 0.173      | 0.181 |
| C    | 1.23        | 1.32  | 0.048      | 0.051 |
| D    | 2.40        | 2.72  | 0.094      | 0.107 |
| E    | 0.49        | 0.70  | 0.019      | 0.027 |
| F    | 0.61        | 0.88  | 0.024      | 0.034 |
| F1   | 1.14        | 1.70  | 0.044      | 0.066 |
| F2   | 1.14        | 1.70  | 0.044      | 0.066 |
| G    | 4.95        | 5.15  | 0.194      | 0.202 |
| G1   | 2.40        | 2.70  | 0.094      | 0.106 |
| H2   | 10          | 10.40 | 0.393      | 0.409 |
| L2   | 16.4 typ.   |       | 0.645 typ. |       |
| L4   | 13          | 14    | 0.511      | 0.551 |
| L5   | 2.65        | 2.95  | 0.104      | 0.116 |
| L6   | 15.25       | 15.75 | 0.600      | 0.620 |
| L7   | 6.20        | 6.60  | 0.244      | 0.259 |
| L9   | 3.50        | 3.93  | 0.137      | 0.154 |
| M    | 2.6 typ.    |       | 0.102 typ. |       |
| Dia. | 3.75        | 3.85  | 0.147      | 0.151 |

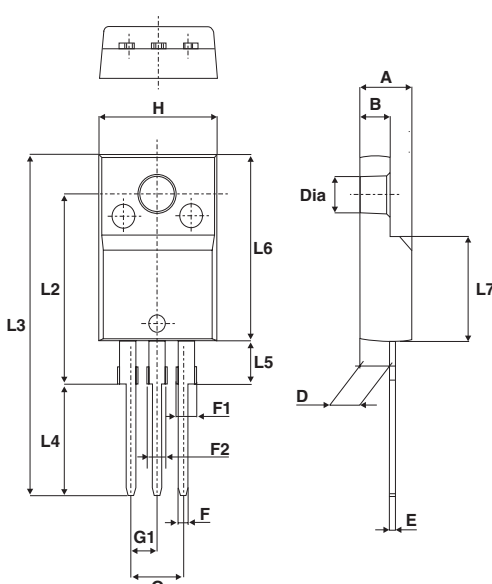
Mounting (soldering) the I<sup>2</sup>PAK metal slug (heatsink) with alloy, like a surface mount device, IS NOT PERMITTED. A standard through-hole mounting is mandatory.

**Table 6. I<sup>2</sup>PAK dimensions**

| Ref. | Dimensions  |       |        |       |
|------|-------------|-------|--------|-------|
|      | Millimeters |       | Inches |       |
|      | Min.        | Max.  | Min.   | Max.  |
| A    | 4.40        | 4.60  | 0.173  | 0.181 |
| A1   | 2.40        | 2.72  | 0.094  | 0.107 |
| b    | 0.61        | 0.88  | 0.024  | 0.035 |
| b1   | 1.14        | 1.70  | 0.044  | 0.067 |
| c    | 0.49        | 0.70  | 0.019  | 0.028 |
| c2   | 1.23        | 1.32  | 0.048  | 0.052 |
| D    | 8.95        | 9.35  | 0.352  | 0.368 |
| e    | 2.40        | 2.70  | 0.094  | 0.106 |
| e1   | 4.95        | 5.15  | 0.195  | 0.203 |
| E    | 10          | 10.40 | 0.394  | 0.409 |
| L    | 13          | 14    | 0.512  | 0.551 |
| L1   | 3.50        | 3.93  | 0.138  | 0.155 |
| L2   | 1.27        | 1.40  | 0.050  | 0.055 |

Table 7. TO-220FPAB package dimensions

| Ref  | Dimensions  |      |           |       |
|------|-------------|------|-----------|-------|
|      | Millimeters |      | Inches    |       |
|      | Min.        | Max. | Min.      | Max.  |
| A    | 4.4         | 4.6  | 0.173     | 0.181 |
| B    | 2.5         | 2.7  | 0.098     | 0.106 |
| D    | 2.5         | 2.75 | 0.098     | 0.108 |
| E    | 0.45        | 0.70 | 0.018     | 0.027 |
| F    | 0.75        | 1    | 0.030     | 0.039 |
| F1   | 1.15        | 1.70 | 0.045     | 0.067 |
| F2   | 1.15        | 1.70 | 0.045     | 0.067 |
| G    | 4.95        | 5.20 | 0.195     | 0.205 |
| G1   | 2.4         | 2.7  | 0.094     | 0.106 |
| H    | 10          | 10.4 | 0.393     | 0.409 |
| L2   | 16 Typ.     |      | 0.63 Typ. |       |
| L3   | 28.6        | 30.6 | 1.126     | 1.205 |
| L4   | 9.8         | 10.6 | 0.386     | 0.417 |
| L5   | 2.9         | 3.6  | 0.114     | 0.142 |
| L6   | 15.9        | 16.4 | 0.626     | 0.646 |
| L7   | 9.00        | 9.30 | 0.354     | 0.366 |
| Dia. | 3.00        | 3.20 | 0.118     | 0.126 |



The technical drawing illustrates the TO-220FPAB package in three views: top, side, and a detail of the mounting tab. The top view shows the package body with dimensions H (width), L2 (pitch), L3 (total length), L4 (lead length), L5 (tab length), L6 (body length), and L7 (tab length). It also shows the positions of the mounting holes (F, F1, F2) and the lead gage length (G). The side view shows the package height (A), the mounting tab height (B), the mounting tab thickness (D), and the mounting tab width (E). The detail view shows the mounting tab with dimensions F, F1, F2, G, and G1. The drawing also includes a dimension for the mounting tab diameter (Dia.).

Table 8. D<sup>2</sup>PAK package dimensions

| Ref | Dimensions  |       |            |       |
|-----|-------------|-------|------------|-------|
|     | Millimeters |       | Inches     |       |
|     | Min.        | Max.  | Min.       | Max.  |
| A   | 4.40        | 4.60  | 0.173      | 0.181 |
| A1  | 2.49        | 2.69  | 0.098      | 0.106 |
| A2  | 0.03        | 0.23  | 0.001      | 0.009 |
| B   | 0.70        | 0.93  | 0.027      | 0.037 |
| B2  | 1.14        | 1.70  | 0.045      | 0.067 |
| C   | 0.45        | 0.60  | 0.017      | 0.024 |
| C2  | 1.23        | 1.36  | 0.048      | 0.054 |
| D   | 8.95        | 9.35  | 0.352      | 0.368 |
| E   | 10.00       | 10.40 | 0.393      | 0.409 |
| G   | 4.88        | 5.28  | 0.192      | 0.208 |
| L   | 15.00       | 15.85 | 0.590      | 0.624 |
| L2  | 1.27        | 1.40  | 0.050      | 0.055 |
| L3  | 1.40        | 1.75  | 0.055      | 0.069 |
| M   | 2.40        | 3.20  | 0.094      | 0.126 |
| R   | 0.40 typ.   |       | 0.016 typ. |       |
| V2  | 0°          | 8°    | 0°         | 8°    |

Figure 13. D<sup>2</sup>PAK footprint dimensions (in millimeters)

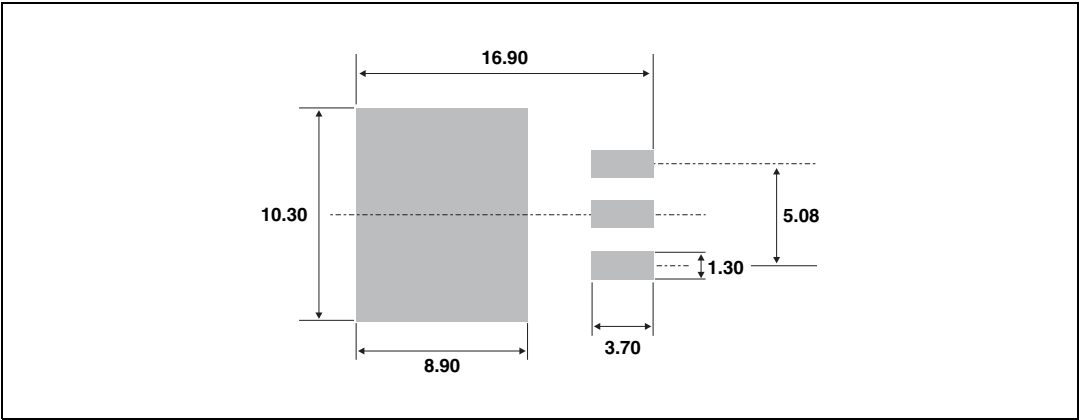


Table 9. TO-247 dimensions

| Ref.              | Dimensions  |       |            |       |
|-------------------|-------------|-------|------------|-------|
|                   | Millimeters |       | Inches     |       |
|                   | Min.        | Max.  | Min.       | Max.  |
| A                 | 4.85        | 5.15  | 0.191      | 0.203 |
| A1                | 2.20        | 2.60  | 0.086      | 0.102 |
| b                 | 1.00        | 1.40  | 0.039      | 0.055 |
| b1                | 2.00        | 2.40  | 0.078      | 0.094 |
| b2                | 3.00        | 3.40  | 0.118      | 0.133 |
| c                 | 0.40        | 0.80  | 0.015      | 0.031 |
| D <sup>(1)</sup>  | 19.85       | 20.15 | 0.781      | 0.793 |
| E                 | 15.45       | 15.75 | 0.608      | 0.620 |
| e                 | 5.45 typ.   |       | 0.215 typ. |       |
| L                 | 14.20       | 14.80 | 0.559      | 0.582 |
| L1                | 3.70        | 4.30  | 0.145      | 0.169 |
| L2                | 18.50 typ.  |       | 0.728 typ. |       |
| ØP <sup>(2)</sup> | 3.55        | 3.65  | 0.139      | 0.143 |
| ØR                | 4.50        | 5.50  | 0.177      | 0.217 |
| S                 | 5.50 typ.   |       | 0.216 typ. |       |

1. Dimension D plus gate protrusion does not exceed 20.5 mm
2. Resin thickness around the mounting hole is not less than 0.9 mm

### 3 Ordering Information

**Table 10. Ordering information**

| Order code     | Marking      | Package            | Weight | Base qty | Delivery mode |
|----------------|--------------|--------------------|--------|----------|---------------|
| STPS30L45CT    | STPS30L45CT  | TO-220AB           | 2g     | 50       | Tube          |
| STPS30L45CG    | STPS30L45CG  | D <sup>2</sup> PAK | 1.8g   | 50       | Tube          |
| STPS30L45CG-TR | STPS30L45CG  | D <sup>2</sup> PAK | 1.8g   | 500      | Tape and reel |
| STPS30L45CW    | STPS30L45CW  | TO-247             | 4.4g   | 30       | Tube          |
| STPS30L45CR    | STPS30L45CR  | I <sup>2</sup> PAK | 1.4g   | 50       | Tube          |
| STPS30L45CFP   | STPS30L45CFP | TO-220FPAB         | 1.9 g  | 50       | Tube          |

### 4 Revision history

**Table 11. Document revision history**

| Date        | Revision | Changes                                                                                                                                                                     |
|-------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Jul-2003    | 3B       | Previous issue                                                                                                                                                              |
| 13-Oct-2010 | 4        | Added paragraph above <a href="#">Table 6</a> and updated I <sup>2</sup> PAK dimensions in <a href="#">Table 6</a> . Updated TO-247 dimensions in <a href="#">Table 9</a> . |

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